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### What is "[Embedded - Microcontrollers](#)"?

"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

### Applications of "[Embedded - Microcontrollers](#)"

#### Details

Product Status	Active
Core Processor	R8C
Core Size	16-Bit
Speed	20MHz
Connectivity	I <sup>2</sup> C, LINbus, SIO, SSU, UART/USART
Peripherals	POR, PWM, Voltage Detect, WDT
Number of I/O	27
Program Memory Size	24KB (24K x 8)
Program Memory Type	FLASH
EEPROM Size	4K x 8
RAM Size	2K x 8
Voltage - Supply (Vcc/Vdd)	1.8V ~ 5.5V
Data Converters	A/D 12x10b; D/A 2x8b
Oscillator Type	Internal
Operating Temperature	-20°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	32-LQFP
Supplier Device Package	32-LQFP (7x7)
Purchase URL	<a href="https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f21335cnfp-50">https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f21335cnfp-50</a>

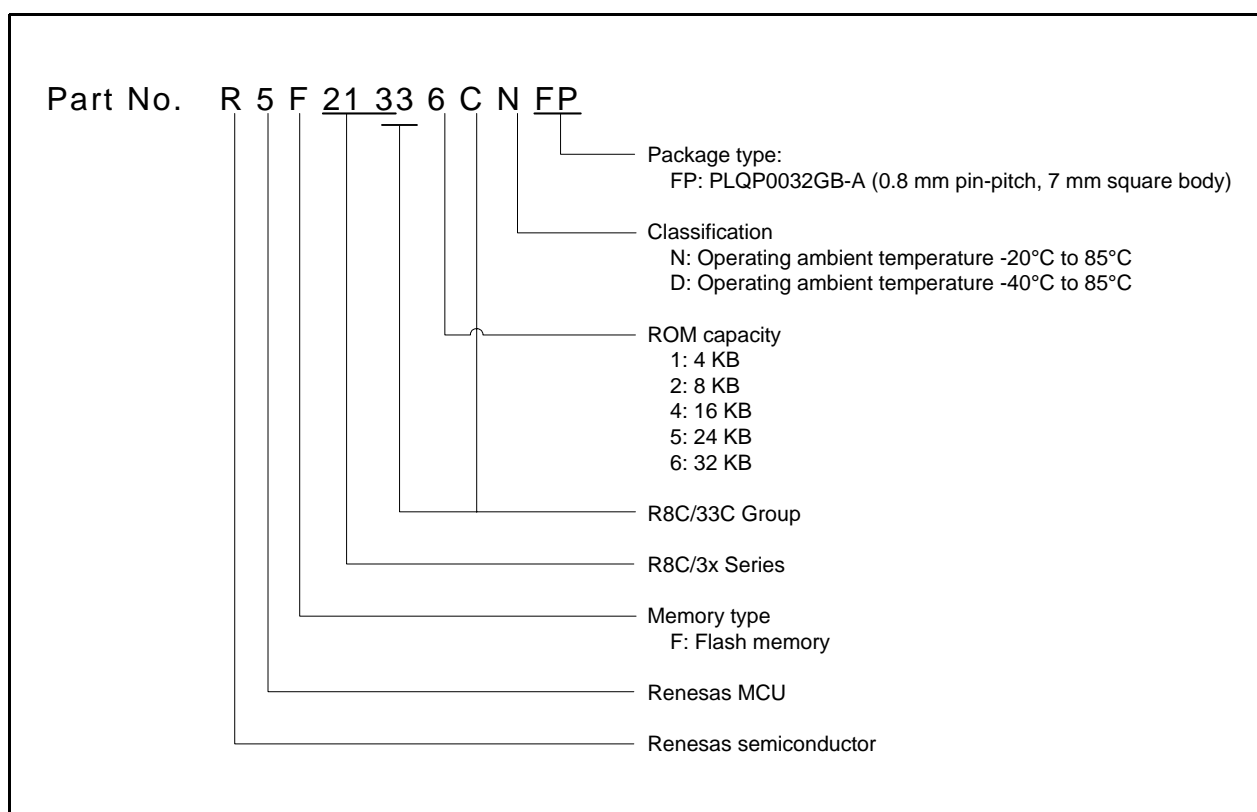
## 1.2 Product List

Table 1.3 lists Product List for R8C/33C Group, and Figure 1.1 shows a Part Number, Memory Size, and Package of R8C/33C Group.

**Table 1.3 Product List for R8C/33C Group**

**Current of Aug 2010**

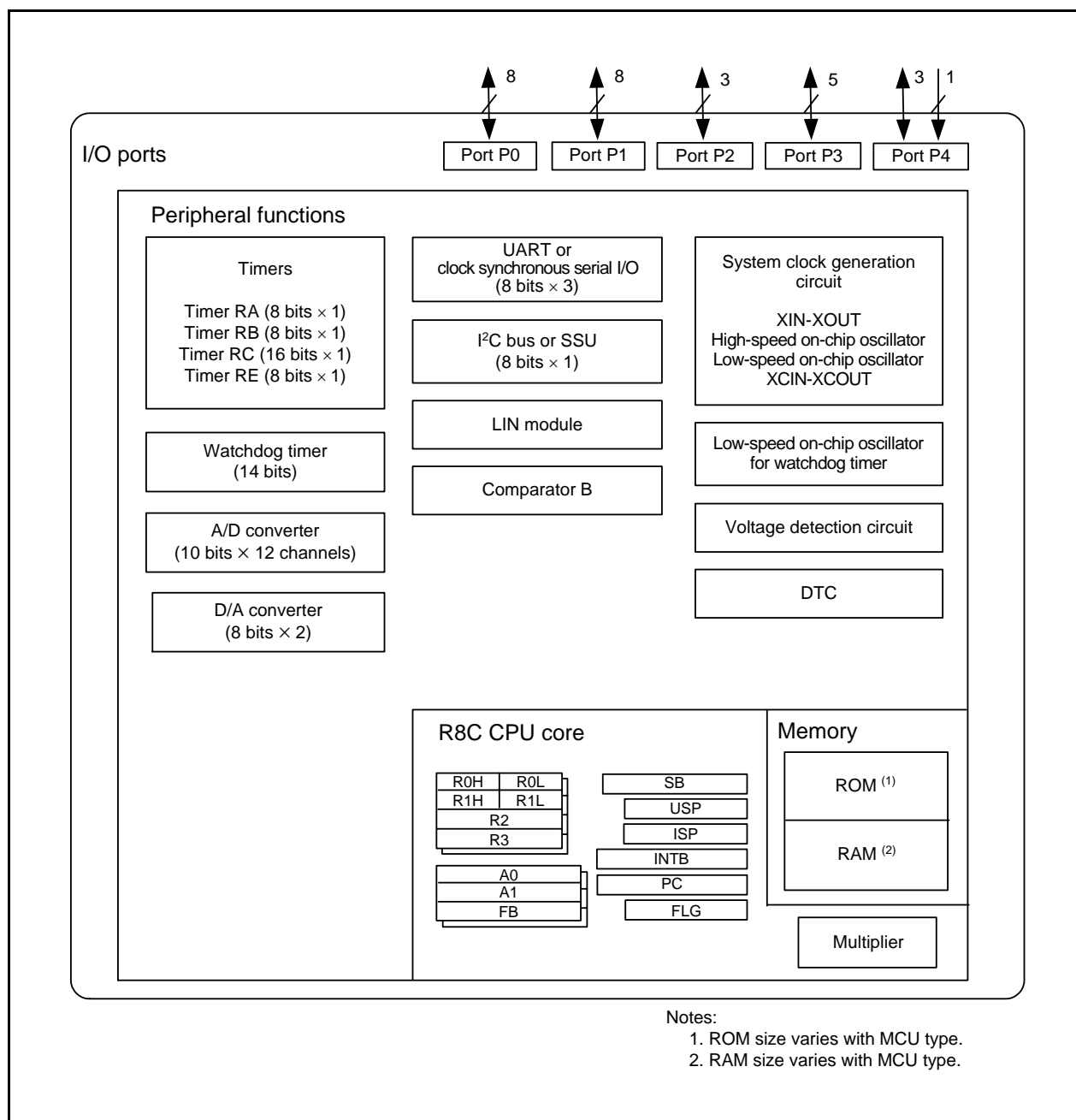
Part No.	ROM Capacity		RAM Capacity	Package Type	Remarks
	Program ROM	Data flash			
R5F21331CNFP	4 Kbytes	1 Kbyte × 4	512 bytes	PLQP0032GB-A	N version
R5F21332CNFP	8 Kbytes	1 Kbyte × 4	1 Kbyte	PLQP0032GB-A	
R5F21334CNFP	16 Kbytes	1 Kbyte × 4	1.5 Kbytes	PLQP0032GB-A	
R5F21335CNFP	24 Kbytes	1 Kbyte × 4	2 Kbytes	PLQP0032GB-A	
R5F21336CNFP	32 Kbytes	1 Kbyte × 4	2.5 Kbytes	PLQP0032GB-A	
R5F21331CDFP	4 Kbytes	1 Kbyte × 4	512 bytes	PLQP0032GB-A	D version
R5F21332CDFP	8 Kbytes	1 Kbyte × 4	1 Kbyte	PLQP0032GB-A	
R5F21334CDFP	16 Kbytes	1 Kbyte × 4	1.5 Kbytes	PLQP0032GB-A	
R5F21335CDFP	24 Kbytes	1 Kbyte × 4	2 Kbytes	PLQP0032GB-A	
R5F21336CDFP	32 Kbytes	1 Kbyte × 4	2.5 Kbytes	PLQP0032GB-A	



**Figure 1.1 Part Number, Memory Size, and Package of R8C/33C Group**

### 1.3 Block Diagram

Figure 1.2 shows a Block Diagram.



**Figure 1.2 Block Diagram**

**Table 1.4 Pin Name Information by Pin Number**

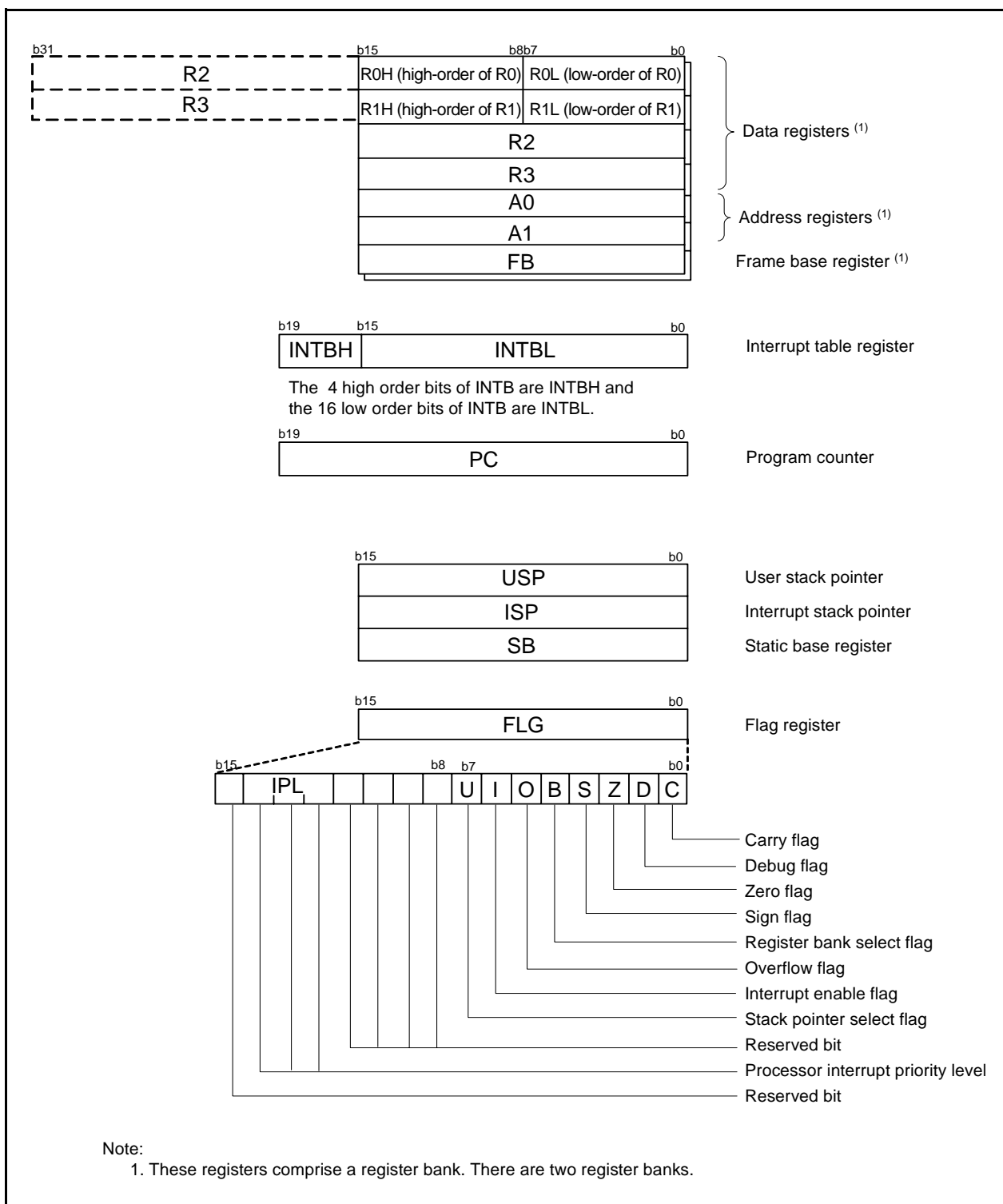
Pin Number	Control Pin	Port	I/O Pin Functions for Peripheral Modules					
			Interrupt	Timer	Serial Interface	SSU	I <sup>2</sup> C bus	A/D Converter, D/A Converter, Comparator B
1		P4_2						VREF
2	MODE							
3	$\overline{\text{RESET}}$							
4	XOUT(/XCOUT)	P4_7						
5	VSS/AVSS							
6	XIN(/XCIN)	P4_6						
7	VCC/AVCC							
8		P3_7		TRAO	(RXD2/SCL2/ TXD2/SDA2)	SSO	SDA	
9		P3_5		(TRCIOD)	(CLK2)	SSCK	SCL	
10		P3_4		(TRCIOC)	(RXD2/SCL2/ TXD2/SDA2)	SSI		IVREF3
11		P3_3	$\overline{\text{INT3}}$	(TRCCLK)	( $\overline{\text{CTS2}}$ /RTS2)	$\overline{\text{SCS}}$		IVCMP3
12		P2_2		(TRCIOD)				
13		P2_1		(TRCIOC)				
14		P2_0	( $\overline{\text{INT1}}$ )	(TRCIOB)				
15		P3_1		(TRBO)				
16		P4_5	$\overline{\text{INT0}}$		(RXD2/SCL2)			$\overline{\text{ADTRG}}$
17		P1_7	$\overline{\text{INT1}}$	(TRAIO)				IVCMP1
18		P1_6			(CLK0)			IVREF1
19		P1_5	( $\overline{\text{INT1}}$ )	(TRAIO)	(RXD0)			
20		P1_4		(TRCCLK)	(TXD0)			
21		P1_3	$\overline{\text{KI3}}$	TRBO (/TRCIOC)				AN11
22		P1_2	$\overline{\text{KI2}}$	(TRCIOB)				AN10
23		P1_1	$\overline{\text{KI1}}$	(TRCIOA/ TRCTRG)				AN9
24		P1_0	$\overline{\text{KI0}}$	(TRCIOD)				AN8
25		P0_7		(TRCIOC)				AN0/DA1
26		P0_6		(TRCIOD)				AN1/DA0
27		P0_5		(TRCIOB)				AN2
28		P0_4		TREO (/TRCIOB)				AN3
29		P0_3		(TRCIOB)	(CLK1)			AN4
30		P0_2		(TRCIOA/ TRCTRG)	(RXD1)			AN5
31		P0_1		(TRCIOA/ TRCTRG)	(TXD1)			AN6
32		P0_0		(TRCIOA/ TRCTRG)				AN7

Note:

1. Can be assigned to the pin in parentheses by a program.

## 2. Central Processing Unit (CPU)

Figure 2.1 shows the CPU Registers. The CPU contains 13 registers. R0, R1, R2, R3, A0, A1, and FB configure a register bank. There are two sets of register bank.



**Figure 2.1 CPU Registers**

### **2.8.7 Interrupt Enable Flag (I)**

The I flag enables maskable interrupts.

Interrupts are disabled when the I flag is set to 0, and are enabled when the I flag is set to 1. The I flag is set to 0 when an interrupt request is acknowledged.

### **2.8.8 Stack Pointer Select Flag (U)**

ISP is selected when the U flag is set to 0; USP is selected when the U flag is set to 1.

The U flag is set to 0 when a hardware interrupt request is acknowledged or the INT instruction of software interrupt numbers 0 to 31 is executed.

### **2.8.9 Processor Interrupt Priority Level (IPL)**

IPL is 3 bits wide and assigns processor interrupt priority levels from level 0 to level 7.

If a requested interrupt has higher priority than IPL, the interrupt is enabled.

### **2.8.10 Reserved Bit**

If necessary, set to 0. When read, the content is undefined.

### 3. Memory

#### 3.1 R8C/33C Group

Figure 3.1 is a Memory Map of R8C/33C Group. The R8C/33C Group has a 1-Mbyte address space from addresses 00000h to FFFFFh. The internal ROM (program ROM) is allocated lower addresses, beginning with address 0FFFFh. For example, a 32-Kbyte internal ROM area is allocated addresses 08000h to 0FFFFh.

The fixed interrupt vector table is allocated addresses 0FFDCh to 0FFFFh. The starting address of each interrupt routine is stored here.

The internal ROM (data flash) is allocated addresses 03000h to 03FFFh.

The internal RAM is allocated higher addresses, beginning with address 00400h. For example, a 2.5-Kbyte internal RAM area is allocated addresses 00400h to 00DFFh. The internal RAM is used not only for data storage but also as a stack area when a subroutine is called or when an interrupt request is acknowledged.

Special function registers (SFRs) are allocated addresses 00000h to 002FFh and 02C00h to 02FFFh. Peripheral function control registers are allocated here. All unallocated spaces within the SFRs are reserved and cannot be accessed by users.

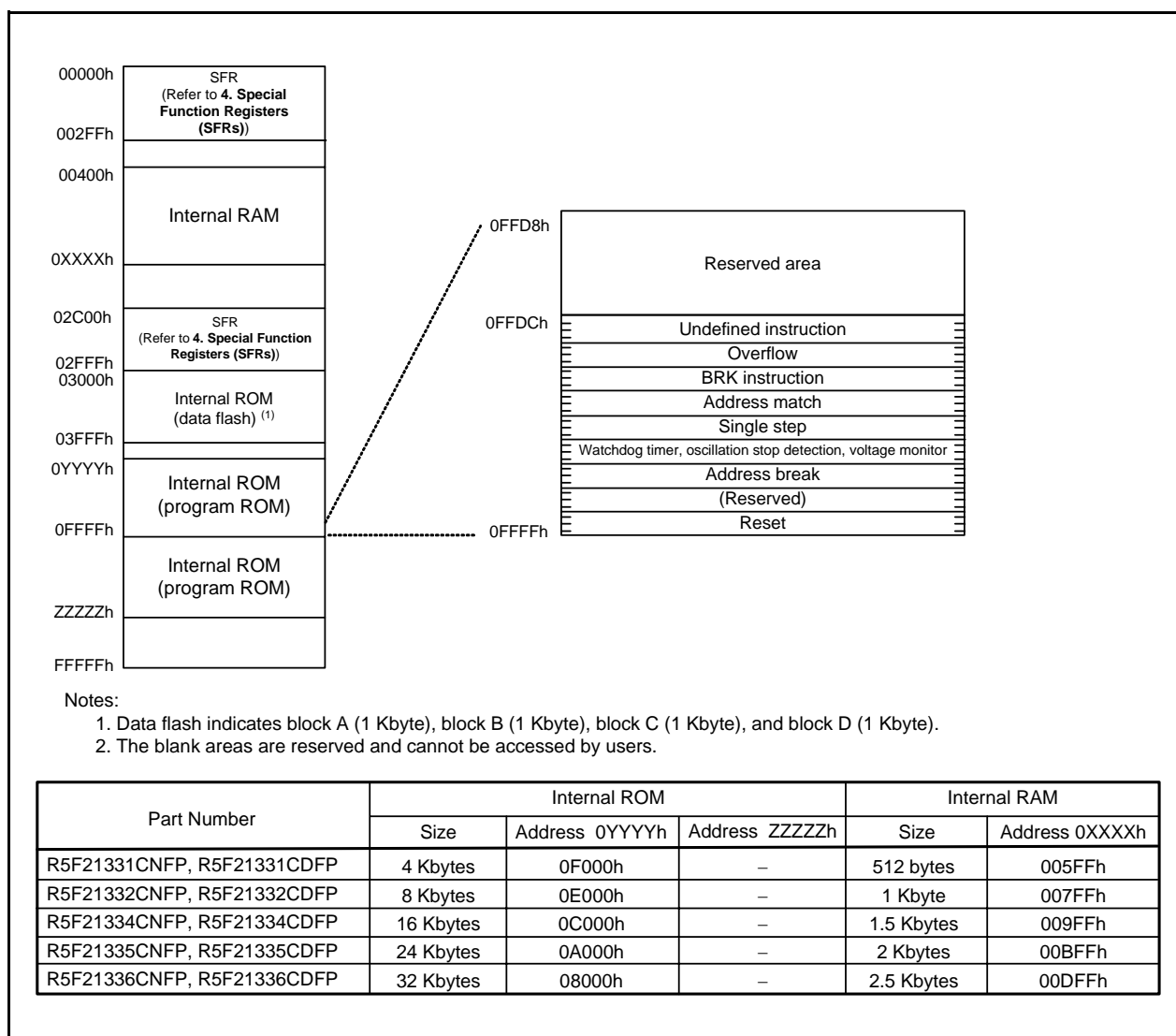


Figure 3.1 Memory Map of R8C/33C Group

**Table 4.2 SFR Information (2) (1)**

Address	Register	Symbol	After Reset
003Ah	Voltage Monitor 2 Circuit Control Register	VW2C	10000010b
003Bh			
003Ch			
003Dh			
003Eh			
003Fh			
0040h			
0041h	Flash Memory Ready Interrupt Control Register	FMRDYIC	XXXXX000b
0042h			
0043h			
0044h			
0045h			
0046h			
0047h	Timer RC Interrupt Control Register	TRCIC	XXXXX000b
0048h			
0049h			
004Ah	Timer RE Interrupt Control Register	TREIC	XXXXX000b
004Bh	UART2 Transmit Interrupt Control Register	S2TIC	XXXXX000b
004Ch	UART2 Receive Interrupt Control Register	S2RIC	XXXXX000b
004Dh	Key Input Interrupt Control Register	KUPIC	XXXXX000b
004Eh	A/D Conversion Interrupt Control Register	ADIC	XXXXX000b
004Fh	SSU Interrupt Control Register / IIC bus Interrupt Control Register (2)	SSUIC / IICIC	XXXXX000b
0050h			
0051h	UART0 Transmit Interrupt Control Register	S0TIC	XXXXX000b
0052h	UART0 Receive Interrupt Control Register	S0RIC	XXXXX000b
0053h	UART1 Transmit Interrupt Control Register	S1TIC	XXXXX000b
0054h	UART1 Receive Interrupt Control Register	S1RIC	XXXXX000b
0055h			
0056h	Timer RA Interrupt Control Register	TRAIC	XXXXX000b
0057h			
0058h	Timer RB Interrupt Control Register	TRBIC	XXXXX000b
0059h	INT1 Interrupt Control Register	INT1IC	XX00X000b
005Ah	INT3 Interrupt Control Register	INT3IC	XX00X000b
005Bh			
005Ch			
005Dh	INT0 Interrupt Control Register	INT0IC	XX00X000b
005Eh	UART2 Bus Collision Detection Interrupt Control Register	U2BCNIC	XXXXX000b
005Fh			
0060h			
0061h			
0062h			
0063h			
0064h			
0065h			
0066h			
0067h			
0068h			
0069h			
006Ah			
006Bh			
006Ch			
006Dh			
006Eh			
006Fh			
0070h			
0071h			
0072h	Voltage Monitor 1 Interrupt Control Register	VCMP1IC	XXXXX000b
0073h	Voltage Monitor 2 Interrupt Control Register	VCMP2IC	XXXXX000b
0074h			
0075h			
0076h			
0077h			
0078h			
0079h			
007Ah			
007Bh			
007Ch			
007Dh			
007Eh			
007Fh			

X: Undefined

Notes:

1. The blank areas are reserved and cannot be accessed by users.
2. Selectable by the IICSEL bit in the SSUICSR register.



**Table 4.4 SFR Information (4) (1)**

Address	Register	Symbol	After Reset
00C0h	A/D Register 0	AD0	XXh
00C1h			000000XXb
00C2h	A/D Register 1	AD1	XXh
00C3h			000000XXb
00C4h	A/D Register 2	AD2	XXh
00C5h			000000XXb
00C6h	A/D Register 3	AD3	XXh
00C7h			000000XXb
00C8h	A/D Register 4	AD4	XXh
00C9h			000000XXb
00CAh	A/D Register 5	AD5	XXh
00CBh			000000XXb
00CCh	A/D Register 6	AD6	XXh
00CDh			000000XXb
00CEh	A/D Register 7	AD7	XXh
00CFh			000000XXb
00D0h			
00D1h			
00D2h			
00D3h			
00D4h	A/D Mode Register	ADMOD	00h
00D5h	A/D Input Select Register	ADINSEL	11000000b
00D6h	A/D Control Register 0	ADCON0	00h
00D7h	A/D Control Register 1	ADCON1	00h
00D8h	D/A0 Register	DA0	00h
00D9h	D/A1 Register	DA1	00h
00DAh			
00DBh			
00DCh	D/A Control Register	DACON	00h
00DDh			
00DEh			
00DFh			
00E0h	Port P0 Register	P0	XXh
00E1h	Port P1 Register	P1	XXh
00E2h	Port P0 Direction Register	PD0	00h
00E3h	Port P1 Direction Register	PD1	00h
00E4h	Port P2 Register	P2	XXh
00E5h	Port P3 Register	P3	XXh
00E6h	Port P2 Direction Register	PD2	00h
00E7h	Port P3 Direction Register	PD3	00h
00E8h	Port P4 Register	P4	XXh
00E9h			
00EAh	Port P4 Direction Register	PD4	00h
00EBh			
00ECh			
00EDh			
00EEh			
00EFh			
00F0h			
00F1h			
00F2h			
00F3h			
00F4h			
00F5h			
00F6h			
00F7h			
00F8h			
00F9h			
00FAh			
00FBh			
00FCh			
00FDh			
00FEh			
00FFh			

X: Undefined

Note:

1. The blank areas are reserved and cannot be accessed by users.

**Table 4.5 SFR Information (5) (1)**

Address	Register	Symbol	After Reset
0100h	Timer RA Control Register	TRACR	00h
0101h	Timer RA I/O Control Register	TRAIOC	00h
0102h	Timer RA Mode Register	TRAMR	00h
0103h	Timer RA Prescaler Register	TRAPRE	FFh
0104h	Timer RA Register	TRA	FFh
0105h	LIN Control Register 2	LINCR2	00h
0106h	LIN Control Register	LINCR	00h
0107h	LIN Status Register	LINST	00h
0108h	Timer RB Control Register	TRBCR	00h
0109h	Timer RB One-Shot Control Register	TRBOCR	00h
010Ah	Timer RB I/O Control Register	TRBIOC	00h
010Bh	Timer RB Mode Register	TRBMR	00h
010Ch	Timer RB Prescaler Register	TRBPRE	FFh
010Dh	Timer RB Secondary Register	TRBSC	FFh
010Eh	Timer RB Primary Register	TRBPR	FFh
010Fh			
0110h			
0111h			
0112h			
0113h			
0114h			
0115h			
0116h			
0117h			
0118h	Timer RE Second Data Register / Counter Data Register	TRESEC	00h
0119h	Timer RE Minute Data Register / Compare Data Register	TREMIN	00h
011Ah	Timer RE Hour Data Register	TREHR	00h
011Bh	Timer RE Day of Week Data Register	TREWK	00h
011Ch	Timer RE Control Register 1	TRECR1	00h
011Dh	Timer RE Control Register 2	TRECR2	00h
011Eh	Timer RE Count Source Select Register	TRECSR	00001000b
011Fh			
0120h	Timer RC Mode Register	TRCMR	01001000b
0121h	Timer RC Control Register 1	TRCCR1	00h
0122h	Timer RC Interrupt Enable Register	TRCIER	01110000b
0123h	Timer RC Status Register	TRCSR	01110000b
0124h	Timer RC I/O Control Register 0	TRCIOR0	10001000b
0125h	Timer RC I/O Control Register 1	TRCIOR1	10001000b
0126h	Timer RC Counter	TRC	00h
0127h			00h
0128h	Timer RC General Register A	TRCGRA	FFh
0129h			FFh
012Ah	Timer RC General Register B	TRCGRB	FFh
012Bh			FFh
012Ch	Timer RC General Register C	TRCGRC	FFh
012Dh			FFh
012Eh	Timer RC General Register D	TRCGRD	FFh
012Fh			FFh
0130h	Timer RC Control Register 2	TRCCR2	00011000b
0131h	Timer RC Digital Filter Function Select Register	TRCDF	00h
0132h	Timer RC Output Master Enable Register	TRCOER	01111111b
0133h	Timer RC Trigger Control Register	TRCADCR	00h
0134h			
0135h			
0136h			
0137h			
0138h			
0139h			
013Ah			
013Bh			
013Ch			
013Dh			
013Eh			
013Fh			

Note:

1. The blank areas are reserved and cannot be accessed by users.

**Table 4.12 SFR Information (12) <sup>(1)</sup>**

Address	Register	Symbol	After Reset
2CF0h	DTC Control Data 22	DTCD22	XXh
2CF1h			XXh
2CF2h			XXh
2CF3h			XXh
2CF4h			XXh
2CF5h			XXh
2CF6h			XXh
2CF7h			XXh
2CF8h	DTC Control Data 23	DTCD23	XXh
2CF9h			XXh
2CFAh			XXh
2CFBh			XXh
2CFCh			XXh
2CFDh			XXh
2CFEh			XXh
2CFFh			XXh
2D00h			
⋮			
2FFFh			

X: Undefined

Note:

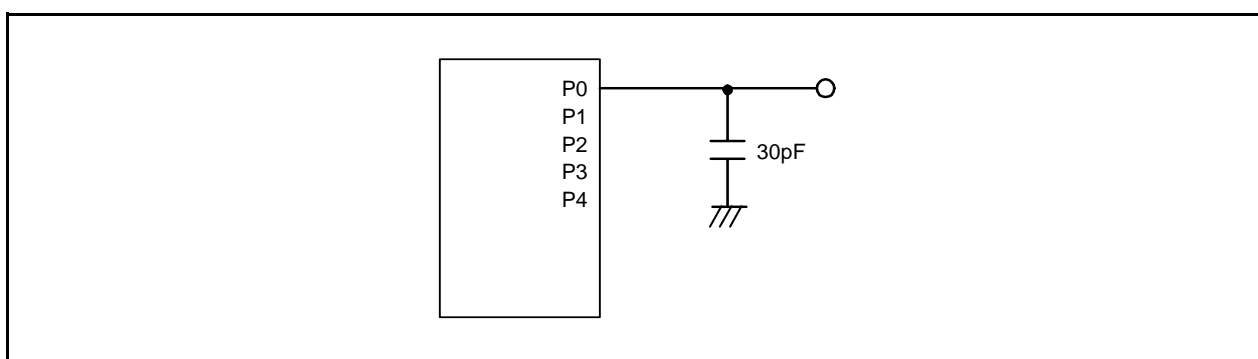
1. The blank areas are reserved and cannot be accessed by users.

**Table 4.13 ID Code Areas and Option Function Select Area**

Address	Area Name	Symbol	After Reset
⋮			
FFDBh	Option Function Select Register 2	OFS2	(Note 1)
⋮			
FFDFh	ID1		(Note 2)
⋮			
FFE3h	ID2		(Note 2)
⋮			
FFEBh	ID3		(Note 2)
⋮			
FFEFh	ID4		(Note 2)
⋮			
FFF3h	ID5		(Note 2)
⋮			
FFF7h	ID6		(Note 2)
⋮			
FFFBh	ID7		(Note 2)
⋮			
FFFFh	Option Function Select Register	OFS	(Note 1)

Notes:

1. The option function select area is allocated in the flash memory, not in the SFRs. Set appropriate values as ROM data by a program. Do not write additions to the option function select area. If the block including the option function select area is erased, the option function select area is set to FFh. When blank products are shipped, the option function select area is set to FFh. It is set to the written value after written by the user. When factory-programming products are shipped, the value of the option function select area is the value programmed by the user.
2. The ID code areas are allocated in the flash memory, not in the SFRs. Set appropriate values as ROM data by a program. Do not write additions to the ID code areas. If the block including the ID code areas is erased, the ID code areas are set to FFh. When blank products are shipped, the ID code areas are set to FFh. They are set to the written value after written by the user. When factory-programming products are shipped, the value of the ID code areas is the value programmed by the user.



**Figure 5.1** Ports P0 to P4 Timing Measurement Circuit

**Table 5.4 D/A Converter Characteristics**

Symbol	Parameter	Condition	Standard			Unit
			Min.	Typ.	Max.	
—	Resolution		—	—	8	Bit
—	Absolute accuracy		—	—	2.5	LSB
$t_{su}$	Setup time		—	—	3	$\mu s$
$R_o$	Output resistor		—	6	—	$k\Omega$
$I_{Vref}$	Reference power input current	(Note 2)	—	—	1.5	mA

Notes:

1.  $V_{CC}/AV_{CC} = V_{ref} = 2.7$  to  $5.5$  V and  $T_{opr} = -20$  to  $85^{\circ}C$  (N version) /  $-40$  to  $85^{\circ}C$  (D version), unless otherwise specified.
2. This applies when one D/A converter is used and the value of the  $DA_i$  register ( $i = 0$  or  $1$ ) for the unused D/A converter is  $00h$ . The resistor ladder of the A/D converter is not included.

**Table 5.5 Comparator B Electrical Characteristics**

Symbol	Parameter	Condition	Standard			Unit
			Min.	Typ.	Max.	
$V_{ref}$	$IVREF1$ , $IVREF3$ input reference voltage		0	—	$V_{CC} - 1.4$	V
$V_I$	$IVCMP1$ , $IVCMP3$ input voltage		$-0.3$	—	$V_{CC} + 0.3$	V
—	Offset		—	5	100	mV
$t_d$	Comparator output delay time <sup>(2)</sup>	$V_I = V_{ref} \pm 100$ mV	—	0.1	—	$\mu s$
$I_{CMP}$	Comparator operating current	$V_{CC} = 5.0$ V	—	17.5	—	$\mu A$

Notes:

1.  $V_{CC} = 2.7$  to  $5.5$  V,  $T_{opr} = -20$  to  $85^{\circ}C$  (N version) /  $-40$  to  $85^{\circ}C$  (D version), unless otherwise specified.
2. When the digital filter is disabled.

**Table 5.8 Voltage Detection 0 Circuit Electrical Characteristics**

Symbol	Parameter	Condition	Standard			Unit
			Min.	Typ.	Max.	
V <sub>det0</sub>	Voltage detection level V <sub>det0_0</sub> (2)		1.80	1.90	2.05	V
	Voltage detection level V <sub>det0_1</sub> (2)		2.15	2.35	2.50	V
	Voltage detection level V <sub>det0_2</sub> (2)		2.70	2.85	3.05	V
	Voltage detection level V <sub>det0_3</sub> (2)		3.55	3.80	4.05	V
—	Voltage detection 0 circuit response time (4)	At the falling of V <sub>cc</sub> from 5 V to (V <sub>det0_0</sub> – 0.1) V	—	6	150	μs
—	Voltage detection circuit self power consumption	VCA25 = 1, V <sub>cc</sub> = 5.0 V	—	1.5	—	μA
t <sub>d(E-A)</sub>	Waiting time until voltage detection circuit operation starts (3)		—	—	100	μs

Notes:

1. The measurement condition is V<sub>cc</sub> = 1.8 V to 5.5 V and T<sub>opr</sub> = –20 to 85°C (N version) / –40 to 85°C (D version).
2. Select the voltage detection level with bits VDSEL0 and VDSEL1 in the OFS register.
3. Necessary time until the voltage detection circuit operates when setting to 1 again after setting the VCA25 bit in the VCA2 register to 0.
4. Time until the voltage monitor 0 reset is generated after the voltage passes V<sub>det0</sub>.

**Table 5.9 Voltage Detection 1 Circuit Electrical Characteristics**

Symbol	Parameter	Condition	Standard			Unit
			Min.	Typ.	Max.	
V <sub>det1</sub>	Voltage detection level V <sub>det1_0</sub> (2)	At the falling of V <sub>cc</sub>	2.00	2.20	2.40	V
	Voltage detection level V <sub>det1_1</sub> (2)	At the falling of V <sub>cc</sub>	2.15	2.35	2.55	V
	Voltage detection level V <sub>det1_2</sub> (2)	At the falling of V <sub>cc</sub>	2.30	2.50	2.70	V
	Voltage detection level V <sub>det1_3</sub> (2)	At the falling of V <sub>cc</sub>	2.45	2.65	2.85	V
	Voltage detection level V <sub>det1_4</sub> (2)	At the falling of V <sub>cc</sub>	2.60	2.80	3.00	V
	Voltage detection level V <sub>det1_5</sub> (2)	At the falling of V <sub>cc</sub>	2.75	2.95	3.15	V
	Voltage detection level V <sub>det1_6</sub> (2)	At the falling of V <sub>cc</sub>	2.85	3.10	3.40	V
	Voltage detection level V <sub>det1_7</sub> (2)	At the falling of V <sub>cc</sub>	3.00	3.25	3.55	V
	Voltage detection level V <sub>det1_8</sub> (2)	At the falling of V <sub>cc</sub>	3.15	3.40	3.70	V
	Voltage detection level V <sub>det1_9</sub> (2)	At the falling of V <sub>cc</sub>	3.30	3.55	3.85	V
	Voltage detection level V <sub>det1_A</sub> (2)	At the falling of V <sub>cc</sub>	3.45	3.70	4.00	V
	Voltage detection level V <sub>det1_B</sub> (2)	At the falling of V <sub>cc</sub>	3.60	3.85	4.15	V
	Voltage detection level V <sub>det1_C</sub> (2)	At the falling of V <sub>cc</sub>	3.75	4.00	4.30	V
	Voltage detection level V <sub>det1_D</sub> (2)	At the falling of V <sub>cc</sub>	3.90	4.15	4.45	V
	Voltage detection level V <sub>det1_E</sub> (2)	At the falling of V <sub>cc</sub>	4.05	4.30	4.60	V
	Voltage detection level V <sub>det1_F</sub> (2)	At the falling of V <sub>cc</sub>	4.20	4.45	4.75	V
—	Hysteresis width at the rising of V <sub>cc</sub> in voltage detection 1 circuit	V <sub>det1_0</sub> to V <sub>det1_5</sub> selected	—	0.07	—	V
		V <sub>det1_6</sub> to V <sub>det1_F</sub> selected	—	0.10	—	V
—	Voltage detection 1 circuit response time (3)	At the falling of V <sub>cc</sub> from 5 V to (V <sub>det1_0</sub> – 0.1) V	—	60	150	μs
—	Voltage detection circuit self power consumption	VCA26 = 1, V <sub>cc</sub> = 5.0 V	—	1.7	—	μA
t <sub>d(E-A)</sub>	Waiting time until voltage detection circuit operation starts (4)		—	—	100	μs

Notes:

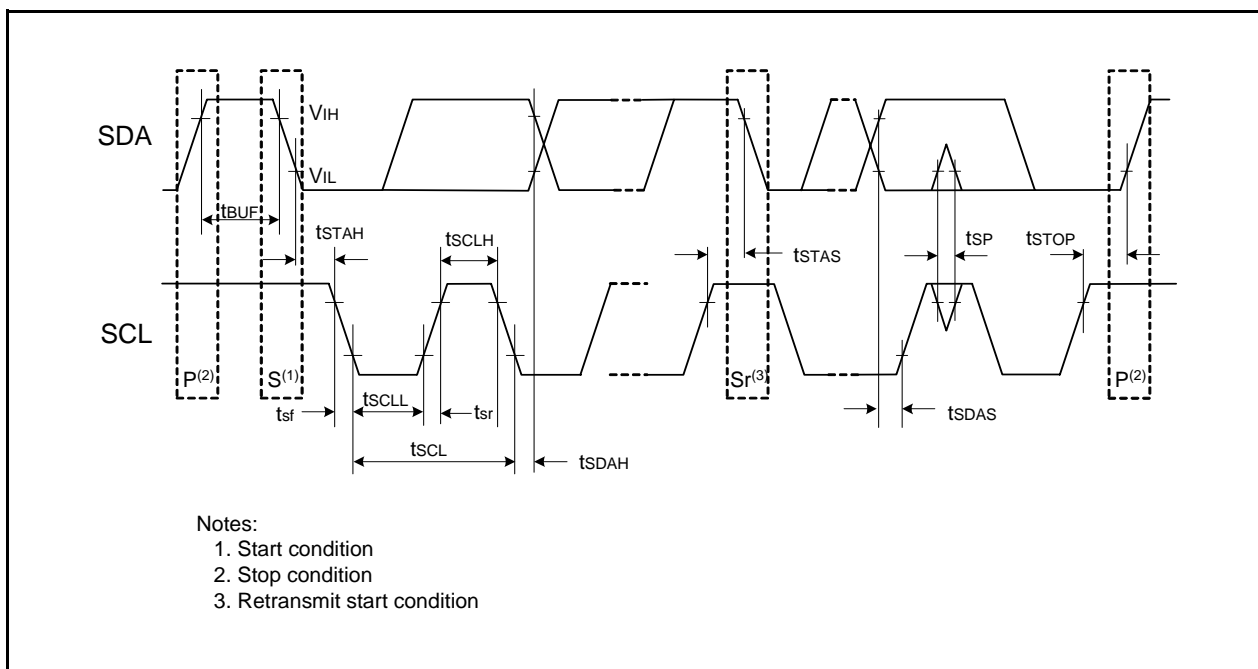
1. The measurement condition is V<sub>cc</sub> = 1.8 V to 5.5 V and T<sub>opr</sub> = –20 to 85°C (N version) / –40 to 85°C (D version).
2. Select the voltage detection level with bits VD1S0 to VD1S3 in the VD1LS register.
3. Time until the voltage monitor 1 interrupt request is generated after the voltage passes V<sub>det1</sub>.
4. Necessary time until the voltage detection circuit operates when setting to 1 again after setting the VCA26 bit in the VCA2 register to 0.

**Table 5.16 Timing Requirements of I<sup>2</sup>C bus Interface (1)**

Symbol	Parameter	Condition	Standard			Unit
			Min.	Typ.	Max.	
t <sub>SCL</sub>	SCL input cycle time		12tcyc + 600 (2)	–	–	ns
t <sub>SCLH</sub>	SCL input “H” width		3tcyc + 300 (2)	–	–	ns
t <sub>SCLL</sub>	SCL input “L” width		5tcyc + 500 (2)	–	–	ns
t <sub>sf</sub>	SCL, SDA input fall time		–	–	300	ns
t <sub>SP</sub>	SCL, SDA input spike pulse rejection time		–	–	1tcyc (2)	ns
t <sub>BUF</sub>	SDA input bus-free time		5tcyc (2)	–	–	ns
t <sub>STAH</sub>	Start condition input hold time		3tcyc (2)	–	–	ns
t <sub>STAS</sub>	Retransmit start condition input setup time		3tcyc (2)	–	–	ns
t <sub>STOP</sub>	Stop condition input setup time		3tcyc (2)	–	–	ns
t <sub>SDAS</sub>	Data input setup time		1tcyc + 40 (2)	–	–	ns
t <sub>SDAH</sub>	Data input hold time		10	–	–	ns

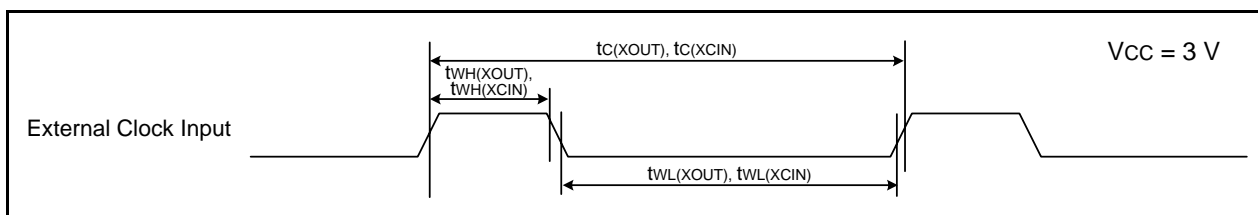
Notes:

1. V<sub>CC</sub> = 1.8 to 5.5 V, V<sub>SS</sub> = 0 V and T<sub>opr</sub> = –20 to 85°C (N version) / –40 to 85°C (D version), unless otherwise specified.
2. 1tcyc = 1/f<sub>1</sub>(s)

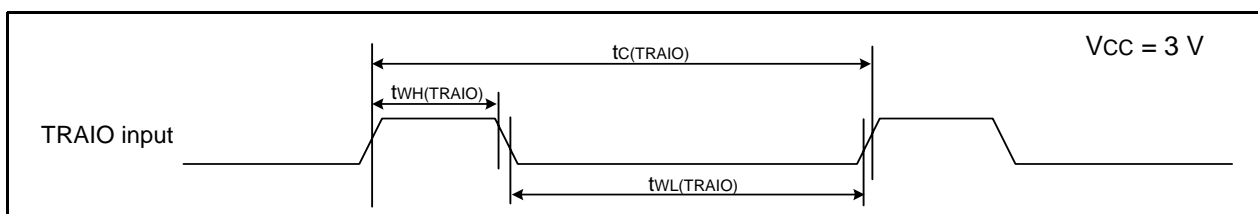
**Figure 5.7 I/O Timing of I<sup>2</sup>C bus Interface**

**Timing requirements****(Unless Otherwise Specified:  $V_{CC} = 3\text{ V}$ ,  $V_{SS} = 0\text{ V}$  at  $T_{opr} = 25^{\circ}\text{C}$ )****Table 5.25 External Clock Input (XOUT, XCIN)**

Symbol	Parameter	Standard		Unit
		Min.	Max.	
$t_{c(XOUT)}$	XOUT input cycle time	50	–	ns
$t_{WH(XOUT)}$	XOUT input "H" width	24	–	ns
$t_{WL(XOUT)}$	XOUT input "L" width	24	–	ns
$t_{c(XCIN)}$	XCIN input cycle time	14	–	$\mu\text{s}$
$t_{WH(XCIN)}$	XCIN input "H" width	7	–	$\mu\text{s}$
$t_{WL(XCIN)}$	XCIN input "L" width	7	–	$\mu\text{s}$

**Figure 5.12 External Clock Input Timing Diagram when  $V_{CC} = 3\text{ V}$** **Table 5.26 TRAIO Input**

Symbol	Parameter	Standard		Unit
		Min.	Max.	
$t_{c(TRAIO)}$	TRAIO input cycle time	300	–	ns
$t_{WH(TRAIO)}$	TRAIO input "H" width	120	–	ns
$t_{WL(TRAIO)}$	TRAIO input "L" width	120	–	ns

**Figure 5.13 TRAIO Input Timing Diagram when  $V_{CC} = 3\text{ V}$**



**Table 5.29 Electrical Characteristics (5) [ $1.8\text{ V} \leq V_{CC} < 2.7\text{ V}$ ]**

Symbol	Parameter		Condition		Standard			Unit
					Min.	Typ.	Max.	
V <sub>OH</sub>	Output "H" voltage	Other than XOUT	Drive capacity High	I <sub>OH</sub> = -2 mA	V <sub>CC</sub> - 0.5	—	V <sub>CC</sub>	V
			Drive capacity Low	I <sub>OH</sub> = -1 mA	V <sub>CC</sub> - 0.5	—	V <sub>CC</sub>	V
		XOUT		I <sub>OH</sub> = -200 $\mu$ A	1.0	—	V <sub>CC</sub>	V
V <sub>OL</sub>	Output "L" voltage	Other than XOUT	Drive capacity High	I <sub>OL</sub> = 2 mA	—	—	0.5	V
			Drive capacity Low	I <sub>OL</sub> = 1 mA	—	—	0.5	V
		XOUT		I <sub>OL</sub> = 200 $\mu$ A	—	—	0.5	V
V <sub>T+</sub> -V <sub>T-</sub>	Hysteresis	INT0, INT1, INT3, KI0, KI1, KI2, KI3, TRAIO, TRBO, TRCIOA, TRCIOB, TRCIOC, TRCIOD, TRCTRG, TRCCLK, ADTRG, RXD0, RXD1, RXD2, CLK0, CLK1, CLK2, SSI, SCL, SDA, SSO			0.05	0.20	—	V
		RESET			0.05	0.2	—	V
I <sub>IH</sub>	Input "H" current		V <sub>I</sub> = 2.2 V, V <sub>CC</sub> = 2.2 V		—	—	4.0	$\mu$ A
I <sub>IL</sub>	Input "L" current		V <sub>I</sub> = 0 V, V <sub>CC</sub> = 2.2 V		—	—	-4.0	$\mu$ A
R <sub>PULLUP</sub>	Pull-up resistance		V <sub>I</sub> = 0 V, V <sub>CC</sub> = 2.2 V		70	140	300	k $\Omega$
R <sub>IXIN</sub>	Feedback resistance	XIN			—	0.3	—	M $\Omega$
R <sub>IXCIN</sub>	Feedback resistance	XCIN			—	8	—	M $\Omega$
V <sub>RAM</sub>	RAM hold voltage		During stop mode		1.8	—	—	V

Note:

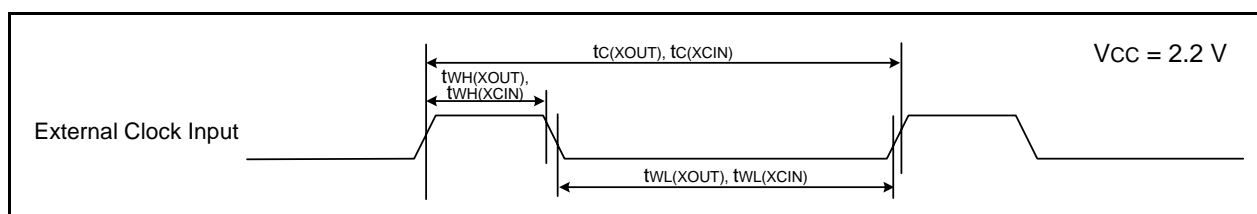
1.  $1.8\text{ V} \leq V_{CC} < 2.7\text{ V}$  and T<sub>opr</sub> = -20 to 85°C (N version) / -40 to 85°C (D version), f(XIN) = 5 MHz, unless otherwise specified.

**Table 5.30 Electrical Characteristics (6) [ $1.8\text{ V} \leq V_{CC} < 2.7\text{ V}$ ]**  
**( $T_{opr} = -20\text{ to }85^{\circ}\text{C}$  (N version) /  $-40\text{ to }85^{\circ}\text{C}$  (D version), unless otherwise specified.)**

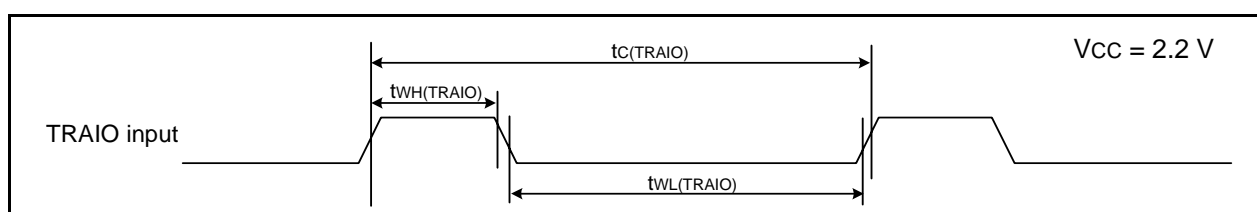
Symbol	Parameter	Condition	Standard			Unit
			Min.	Typ.	Max.	
I <sub>CC</sub>	Power supply current ( $V_{CC} = 1.8\text{ to }2.7\text{ V}$ ) Single-chip mode, output pins are open, other pins are V <sub>SS</sub>	High-speed clock mode	—	2.2	—	mA
				0.8	—	mA
		High-speed on-chip oscillator mode	—	2.5	10	mA
			—	1.7	—	mA
			—	1	—	mA
		Low-speed on-chip oscillator mode	—	90	300	μA
			—	80	350	μA
		Low-speed clock mode	—	40	—	μA
			—	—	—	μA
		Wait mode	—	15	90	μA
			—	4	80	μA
			—	3.5	—	μA
		Stop mode	—	2.0	5	μA
			—	5.0	—	μA

**Timing requirements****(Unless Otherwise Specified:  $V_{CC} = 2.2\text{ V}$ ,  $V_{SS} = 0\text{ V}$  at  $T_{opr} = 25^\circ\text{C}$ )****Table 5.31 External Clock Input (XOUT, XCIN)**

Symbol	Parameter	Standard		Unit
		Min.	Max.	
$t_{c(XOUT)}$	XOUT input cycle time	200	–	ns
$t_{WH(XOUT)}$	XOUT input “H” width	90	–	ns
$t_{WL(XOUT)}$	XOUT input “L” width	90	–	ns
$t_{c(XCIN)}$	XCIN input cycle time	14	–	$\mu\text{s}$
$t_{WH(XCIN)}$	XCIN input “H” width	7	–	$\mu\text{s}$
$t_{WL(XCIN)}$	XCIN input “L” width	7	–	$\mu\text{s}$

**Figure 5.16 External Clock Input Timing Diagram when  $V_{CC} = 2.2\text{ V}$** **Table 5.32 TRAIO Input**

Symbol	Parameter	Standard		Unit
		Min.	Max.	
$t_{c(TRAIO)}$	TRAIO input cycle time	500	–	ns
$t_{WH(TRAIO)}$	TRAIO input “H” width	200	–	ns
$t_{WL(TRAIO)}$	TRAIO input “L” width	200	–	ns

**Figure 5.17 TRAIO Input Timing Diagram when  $V_{CC} = 2.2\text{ V}$**

REVISION HISTORY	R8C/33C Group Datasheet
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Rev.	Date	Description	
		Page	Summary
0.01	Sep. 01, 2009	–	First Edition issued
1.00	Aug. 24, 2010	All 4 26 to 52	“Preliminary” and “Under development” deleted Table1.3 revised “5. Electrical Characteristics” added

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